

General Description

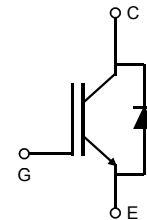
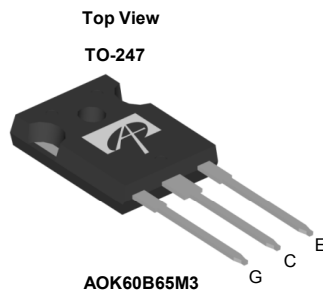
- Latest Alpha IGBT (α IGBT) technology
- 650V breakdown voltage
- Very fast and soft recovery freewheeling diode
- High efficient turn-on di/dt controllability
- Low VCE(SAT) enables high efficiencies
- Low turn-off switching loss and softness
- Very good EMI behavior
- High short-circuit ruggedness

Applications

- Motor Drives
- Welding Machines
- UPS and Solar Inverters
- Other hard switching applications

Product Summary

V_{CE}	650V
I_C ($T_C=100^\circ\text{C}$)	60A
$V_{CE(sat)}$ ($T_J=25^\circ\text{C}$)	1.94V



Orderable Part Number	Package Type	Form	Minimum Order Quantity
AOK60B65M3	TO247	Tube	240
Absolute Maximum Ratings $T_A=25^\circ\text{C}$ unless otherwise noted			
Parameter	Symbol	AOK60B65M3	Units
Collector-Emitter Voltage	V_{CE}	650	V
Gate-Emitter Voltage	V_{GE}	± 30	V
Continuous Collector Current	I_C	$T_C=25^\circ\text{C}$	120
		$T_C=100^\circ\text{C}$	60
Pulsed Collector Current, Limited by T_{Jmax}	I_{CM}	180	A
Turn off SOA, $V_{CE} \leq 650\text{V}$, Limited by T_{Jmax}	I_{LM}	180	A
Continuous Diode Forward Current	I_F	$T_C=25^\circ\text{C}$	60
		$T_C=100^\circ\text{C}$	30
Diode Pulsed Current, Limited by T_{Jmax}	I_{FM}	180	A
Short circuit withstanding time t_1 $V_{GE} = 15\text{V}$, $V_{CC} \leq 400\text{V}$, $T_J \leq 175^\circ\text{C}$	t_{SC}	5	μs
Power Dissipation	P_D	$T_C=25^\circ\text{C}$	500
		$T_C=100^\circ\text{C}$	250
Junction and Storage Temperature Range	T_J, T_{STG}	-55 to 175	$^\circ\text{C}$
Maximum lead temperature for soldering purpose, 1/8" from case for 5 seconds	T_L	300	$^\circ\text{C}$
Thermal Characteristics			
Parameter	Symbol	AOK60B65M3	Units
Maximum Junction-to-Ambient	$R_{\theta JA}$	40	$^\circ\text{C/W}$
Maximum IGBT Junction-to-Case	$R_{\theta JC}$	0.3	$^\circ\text{C/W}$
Maximum Diode Junction-to-Case	$R_{\theta JC}$	1	$^\circ\text{C/W}$

1) Allowed number of short circuits: <1000; time between short circuits: >1s.

Electrical Characteristics (T_J=25°C unless otherwise noted)

Symbol	Parameter	Conditions	Min	Typ	Max	Units	
STATIC PARAMETERS							
BV_{CES}	Collector-Emitter Breakdown Voltage	$I_C=1mA, V_{GE}=0V, T_J=25^\circ C$	650	-	-	V	
$V_{CE(sat)}$	Collector-Emitter Saturation Voltage	$V_{GE}=15V, I_C=60A$	$T_J=25^\circ C$	-	1.94	2.45	V
			$T_J=125^\circ C$	-	2.35	-	
			$T_J=175^\circ C$	-	2.6	-	
V_F	Diode Forward Voltage	$V_{GE}=0V, I_C=60A$	$T_J=25^\circ C$	-	1.91	2.4	V
			$T_J=125^\circ C$	-	2.15	-	
			$T_J=175^\circ C$	-	2.1	-	
$V_{GE(th)}$	Gate-Emitter Threshold Voltage	$V_{CE}=5V, I_C=1mA$	-	4.8	-	V	
I_{CES}	Zero Gate Voltage Collector Current	$V_{CE}=650V, V_{GE}=0V$	$T_J=25^\circ C$	-	-	10	μA
			$T_J=125^\circ C$	-	-	1000	
			$T_J=175^\circ C$	-	-	15000	
I_{GES}	Gate-Emitter leakage current	$V_{CE}=0V, V_{GE}=\pm 30V$	-	-	±100	nA	
g_{FS}	Forward Transconductance	$V_{CE}=20V, I_C=60A$	-	35	-	S	
DYNAMIC PARAMETERS							
C_{ies}	Input Capacitance	$V_{GE}=0V, V_{CC}=25V, f=1MHz$	-	2800	-	pF	
C_{oes}	Output Capacitance		-	330	-	pF	
C_{res}	Reverse Transfer Capacitance		-	118	-	pF	
Q_g	Total Gate Charge	$V_{GE}=15V, V_{CC}=520V, I_C=60A$	-	106	-	nC	
Q_{ge}	Gate to Emitter Charge		-	35	-	nC	
Q_{gc}	Gate to Collector Charge		-	41	-	nC	
$I_{C(SC)}$	Short circuit collector current	$V_{GE}=15V, V_{CC}=400V,$ $t_{sc} \leq 5\mu s, T_J \leq 175^\circ C$	-	222	-	A	
R_g	Gate resistance	$V_{GE}=0V, V_{CC}=0V, f=1MHz$	-	14	-	Ω	
SWITCHING PARAMETERS, (Load Inductive, T_J=25°C)							
$t_{D(on)}$	Turn-On Delay Time	$T_J=25^\circ C$ $V_{GE}=15V, V_{CC}=400V, I_C=60A,$ $R_G=5\Omega$	-	44	-	ns	
t_r	Turn-On Rise Time		-	84	-	ns	
$t_{D(off)}$	Turn-Off Delay Time		-	166	-	ns	
t_f	Turn-Off Fall Time		-	75	-	ns	
E_{on}	Turn-On Energy		-	2.6	-	mJ	
E_{off}	Turn-Off Energy		-	1.3	-	mJ	
E_{total}	Total Switching Energy		-	3.9	-	mJ	
t_{rr}	Diode Reverse Recovery Time		$T_J=25^\circ C$	-	346	-	ns
Q_{rr}	Diode Reverse Recovery Charge		$I_F=60A, di/dt=200A/\mu s, V_{CC}=400V$	-	1.3	-	μC
I_{rm}	Diode Peak Reverse Recovery Current			-	7.5	-	A
SWITCHING PARAMETERS, (Load Inductive, T_J=175°C)							
$t_{D(on)}$	Turn-On Delay Time	$T_J=175^\circ C$ $V_{GE}=15V, V_{CC}=400V, I_C=60A,$ $R_G=5\Omega$	-	42	-	ns	
t_r	Turn-On Rise Time		-	83	-	ns	
$t_{D(off)}$	Turn-Off Delay Time		-	208	-	ns	
t_f	Turn-Off Fall Time		-	77	-	ns	
E_{on}	Turn-On Energy		-	2.9	-	mJ	
E_{off}	Turn-Off Energy		-	1.9	-	mJ	
E_{total}	Total Switching Energy		-	4.8	-	mJ	
t_{rr}	Diode Reverse Recovery Time		$T_J=175^\circ C$	-	557	-	ns
Q_{rr}	Diode Reverse Recovery Charge		$I_F=60A, di/dt=200A/\mu s, V_{CC}=400V$	-	3.1	-	μC
I_{rm}	Diode Peak Reverse Recovery Current			-	11	-	A

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TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS

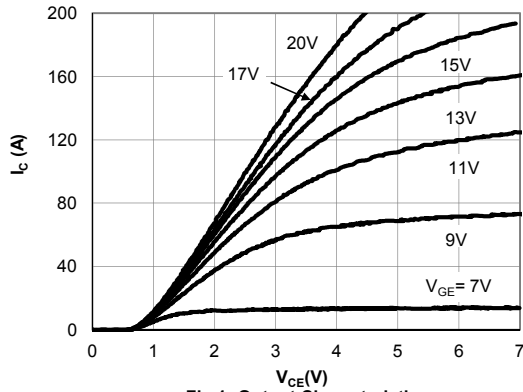


Fig 1: Output Characteristic
($T_j=25^\circ\text{C}$)

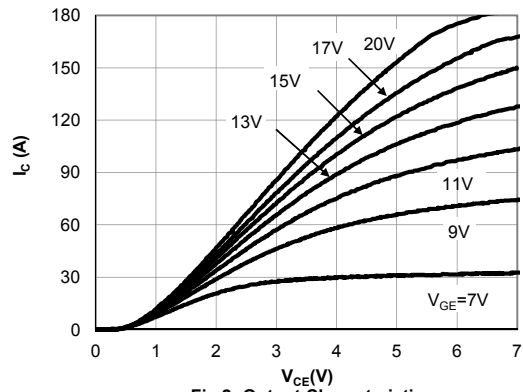


Fig 2: Output Characteristic
($T_j=175^\circ\text{C}$)

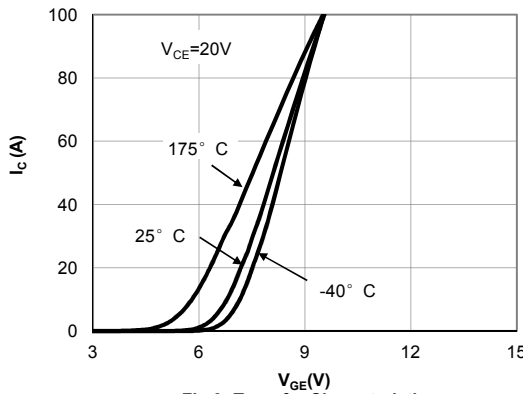


Fig 3: Transfer Characteristic

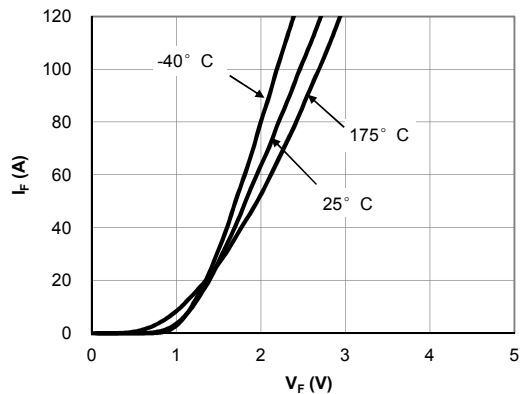


Fig 4: Diode Characteristic

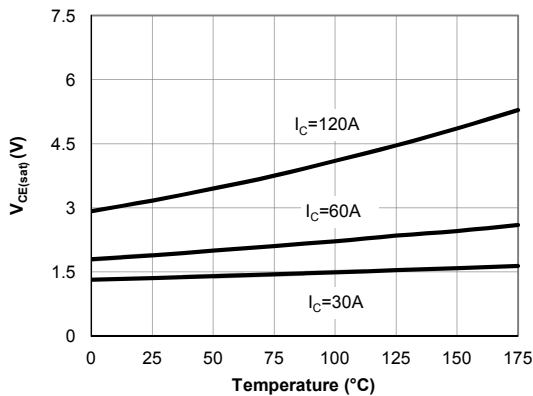


Fig 5: Collector-Emitter Saturation Voltage vs. Junction Temperature

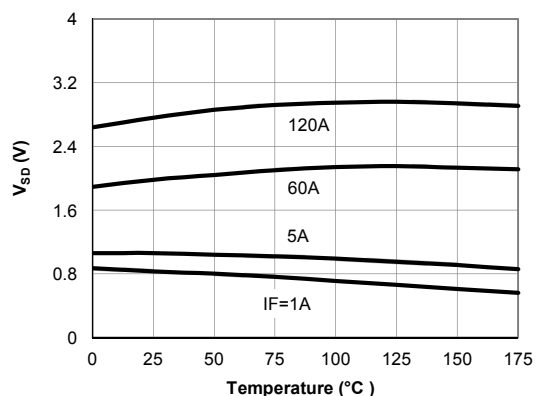
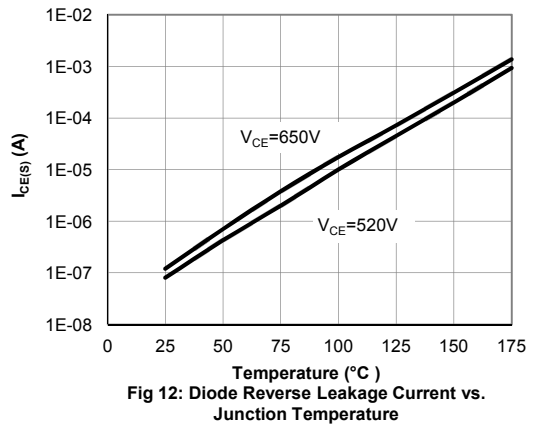
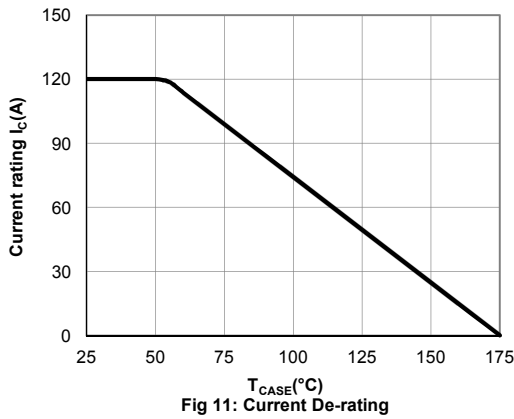
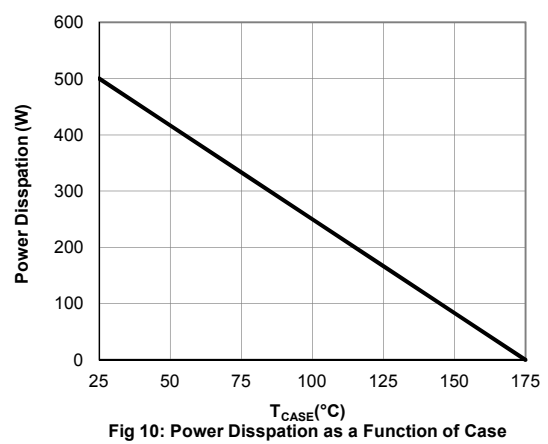
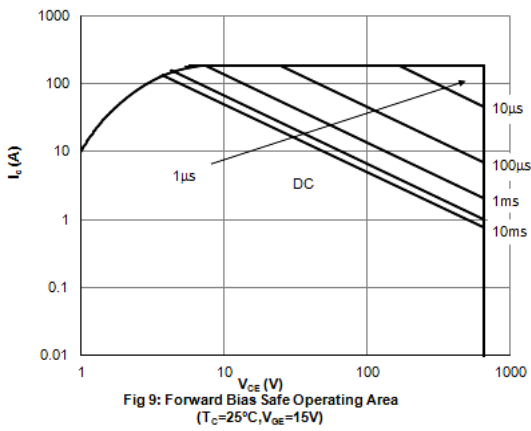
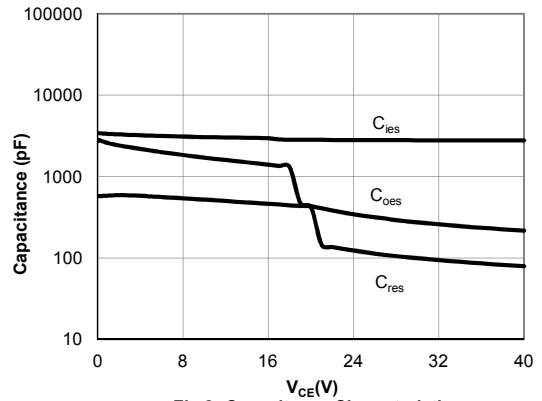
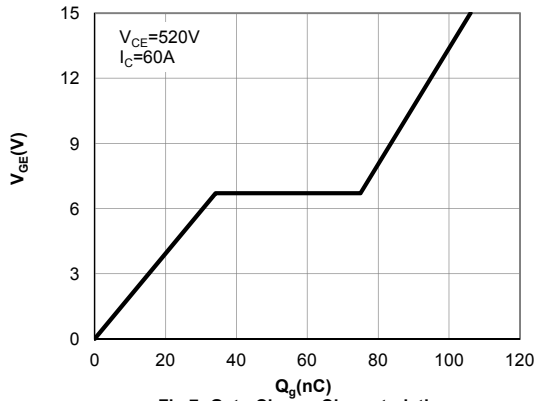


Fig 6: Diode Forward voltage vs. Junction Temperature

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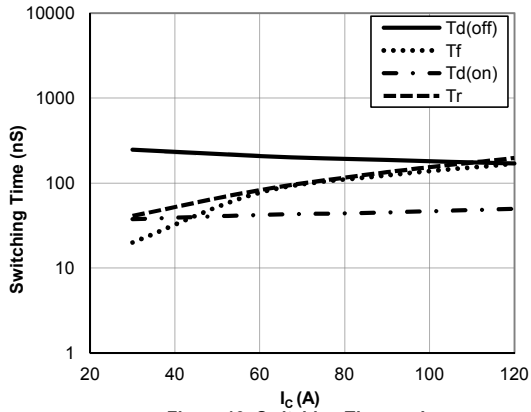


Figure 13: Switching Time vs. I_C
($T_J=175^\circ\text{C}, V_{GE}=15\text{V}, V_{CE}=400\text{V}, R_g=5\Omega$)

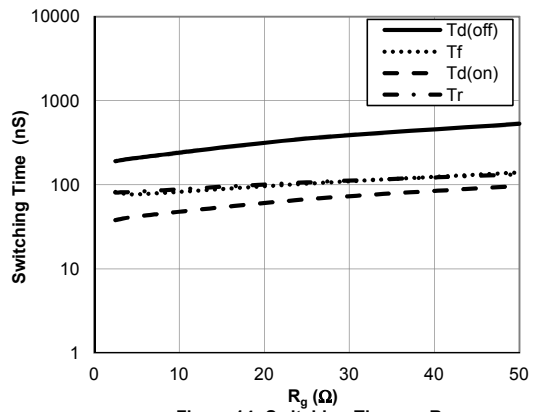


Figure 14: Switching Time vs. R_g
($T_J=175^\circ\text{C}, V_{GE}=15\text{V}, V_{CE}=400\text{V}, I_C=60\text{A}$)

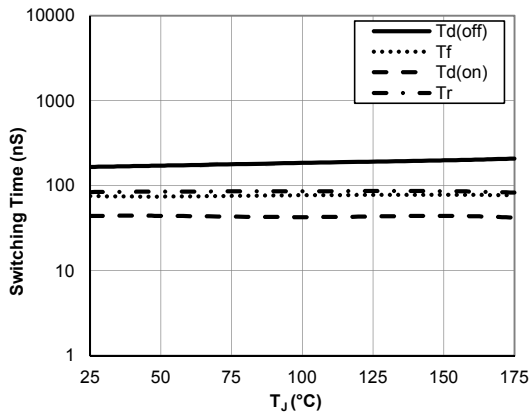


Figure 15: Switching Time vs. T_J
($V_{GE}=15\text{V}, V_{CE}=400\text{V}, I_C=60\text{A}, R_g=5\Omega$)

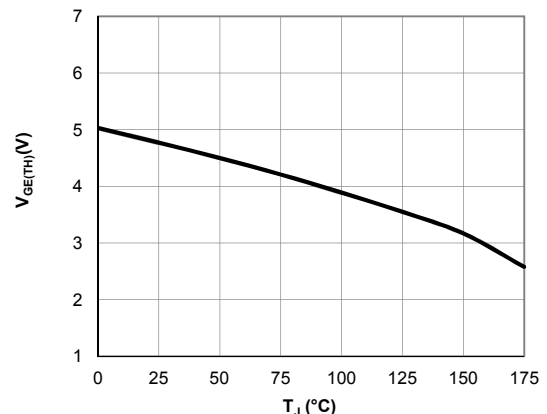


Figure 16: $V_{GE(TH)}$ vs. T_J

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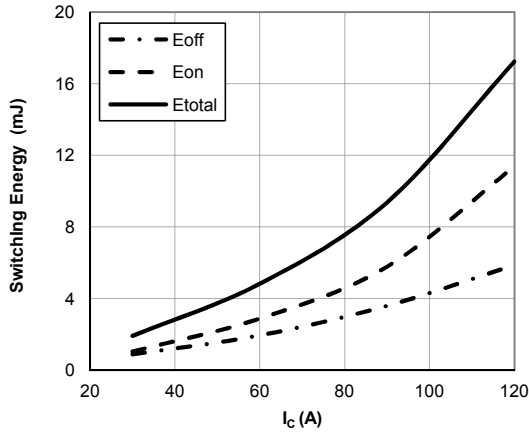


Figure 17: Switching Loss vs. I_c
($T_j=175^\circ\text{C}, V_{GE}=15\text{V}, V_{CE}=400\text{V}, R_g=5\Omega$)

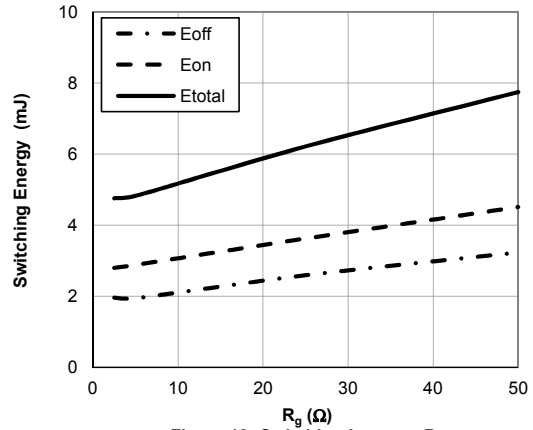


Figure 18: Switching Loss vs. R_g
($T_j=175^\circ\text{C}, V_{GE}=15\text{V}, V_{CE}=400\text{V}, I_c=60\text{A}$)

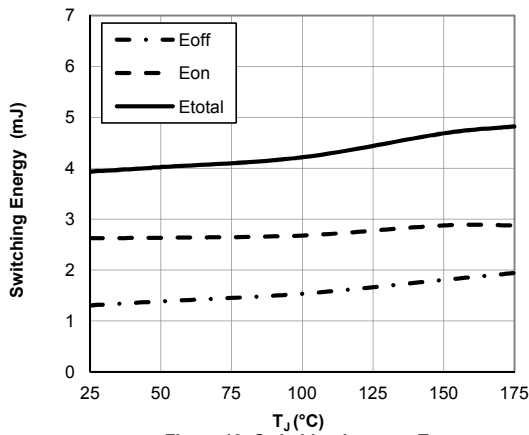


Figure 19: Switching Loss vs. T_j
($V_{GE}=15\text{V}, V_{CE}=400\text{V}, I_c=60\text{A}, R_g=5\Omega$)

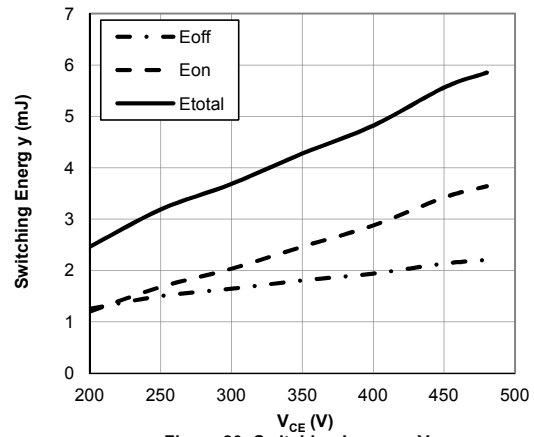


Figure 20: Switching Loss vs. V_{CE}
($T_j=175^\circ\text{C}, V_{GE}=15\text{V}, I_c=60\text{A}, R_g=5\Omega$)

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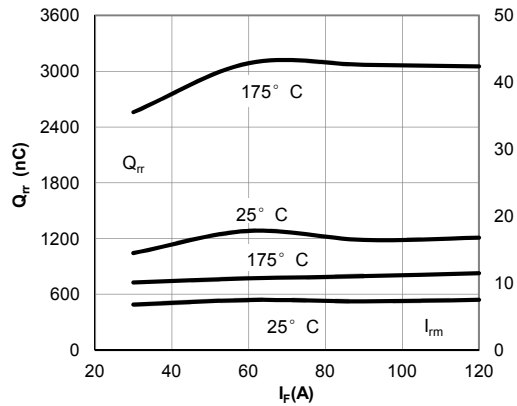


Fig 21: Diode Reverse Recovery Charge and Peak Current vs. Conduction Current
($V_{GE}=15V, V_{CE}=400V, di/dt=200A/\mu s$)

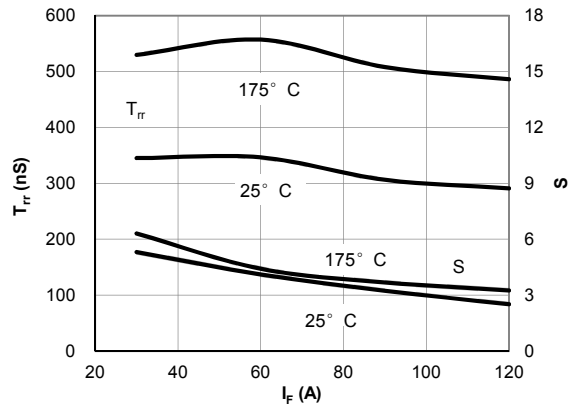


Fig 22: Diode Reverse Recovery Time and Softness Factor vs. Conduction Current
($V_{GE}=15V, V_{CE}=400V, di/dt=200A/\mu s$)

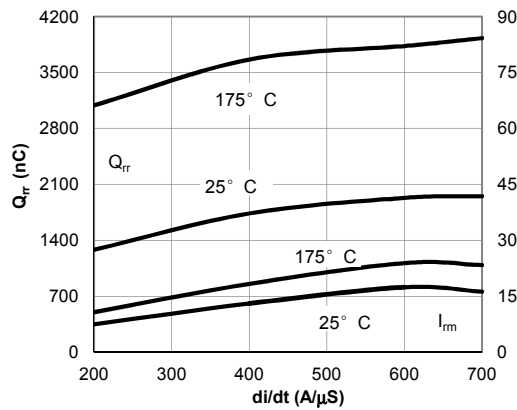


Fig 23: Diode Reverse Recovery Charge and Peak Current vs. di/dt
($V_{GE}=15V, V_{CE}=400V, I_f=60A$)

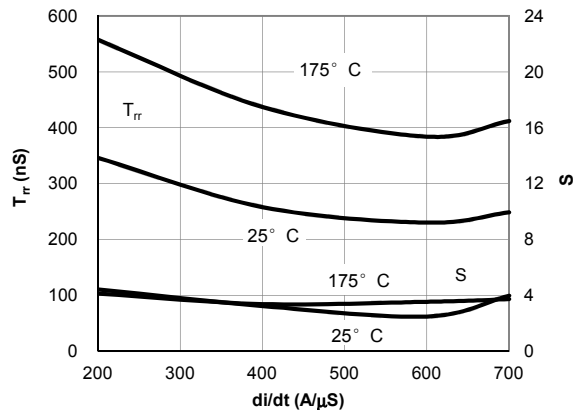


Fig 24: Diode Reverse Recovery Time and Softness Factor vs. di/dt
($V_{GE}=15V, V_{CE}=400V, I_f=60A$)

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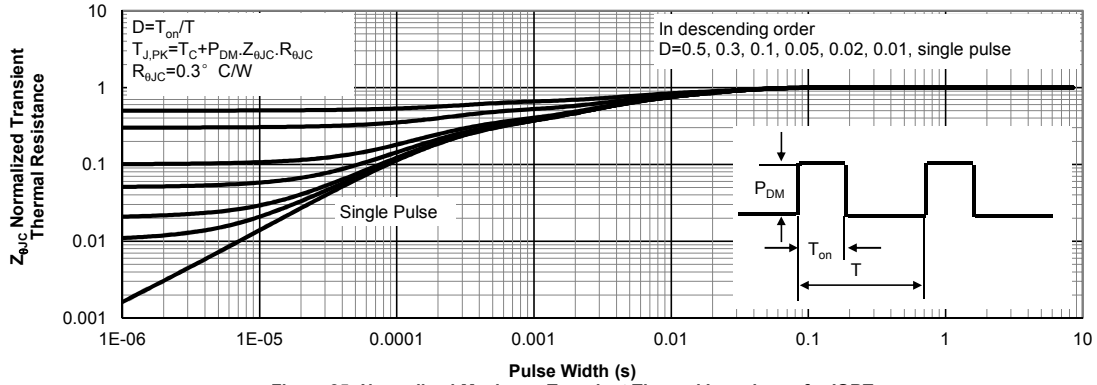


Figure 25: Normalized Maximum Transient Thermal Impedance for IGBT

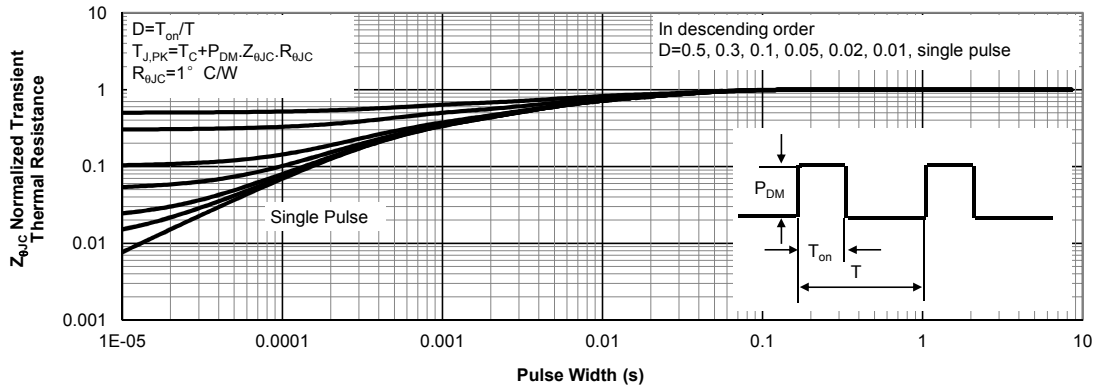
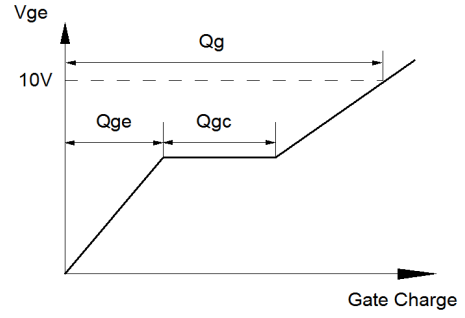
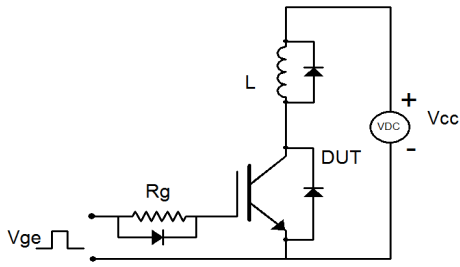
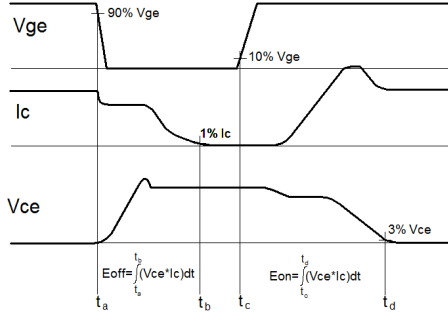
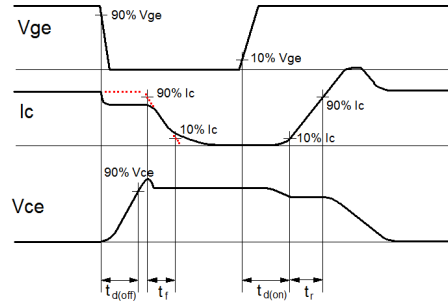
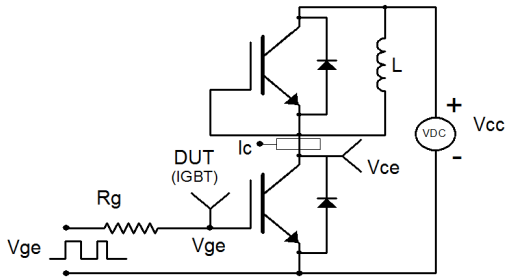


Figure 26: Normalized Maximum Transient Thermal Impedance for Diode

Gate Charge Test Circuit & Waveform



Inductive Switching Test Circuit & Waveforms



Diode Recovery Test Circuit & Waveforms

